

















Datasheet

AUO

P238HAN01.0

UP-02-148

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Model Name: P238HAN01.0

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(*)Final Specifications

(*)Final Specifications

Customer Sig	nature Date	AUO	Date
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scre	ews41



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8.6.	Avoid scratching LCM, th	e rib on system front-cover should not exceed the bottom
edge	of LCM's front-bezel	41



Record of Revision

Version	Date	Page	Description			
0.0	2016/04/14		First release			
0.1	2016/08/31	40-41	Add "8.Design Guide for System"			
0.1	2016/08/31	12	Drawing modified			
0.2	2016/11/03	5	Power Consumption: TBD => 14.6			
0.2		5	PDD (Typ.): TBD => 3.0			
0.2		34	Add carton label information			
0.2		38	7.3 (2) A: 20 hours => 16 hours			
0.2			Final Spec. released			
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1. General Description

This specification applies to the 23.8 inch wide Color a-Si TFT-LCD Module P238HAN01.0. The display supports the Full HD - 1920(H) x 1080(V) screen format and 16.7M colors (8 bits RGB data input). The input interface is Dual channel LVDS and this module doesn't contain a driver board for backlights.

* General Information

1.1. Display Characteristics

The following items are characteristics summary on the table under 25°C condition:

ITEMS	Unit	SPECIFICATIONS			
Screen Diagonal	[mm]	604.70 (23.8")			
Active Area	[mm]	527.04(H) x 296.46(V)			
Pixels H x V	-	1920(x3) x 1080			
Pixel Pitch	[um]	274.5 (per one triad) ×274.5			
Pixel Arrangement	-:50/0	R.G.B. Vertical Stripe			
Display Mode	D	AHVA, normally Black			
White Luminance (Center)	[cd/m2]	300 (Typ.)			
Contrast Ratio	- 10	1000 (Typ.)			
Response Time	[msec]	14 (Typ., G/G)			
Power Consumption	[Watt]	14.6 (Typ.)			
(LCD Module + Backligh unit)		LCD module : PDD (Typ.)=3.0 @ White pattern, Fv=60Hz			
		Backlight unit : PBLU (Typ.) =11.6 @Is=55mA			
Weight	[Grams]	2280+/-80			
Outline Dimension	[mm]	543.0(H) x 317.4(V) x 11.2(D) (Typ.)			
Electrical Interface		Dual channel LVDS , 8-bit RGB data input			
Support Color	aisP"	16.7M colors			
Surface Treatment	7	Anti-Glare, 3H			
Temperature Range	0/2	100			
Operating	[℃]	0 to +50			
Storage (Shipping)	[℃]	-20 to +60			
RoHS Compliance	-	RoHS Compliance			
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1.2. Optical Characteristics

The optical characteristics are measured on the following test condition.

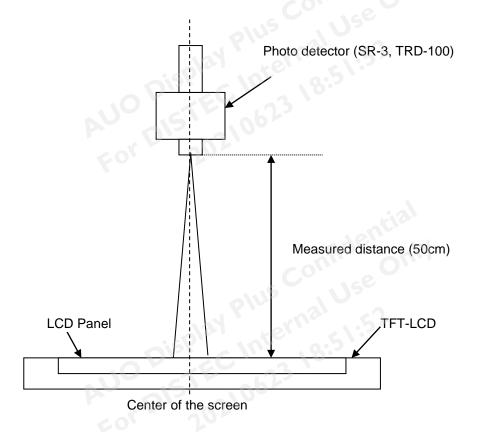
Test Condition:

Equipment setup: Please refer to Note 1-1.
 Panel Lighting time: 30 minutes
 VDD=5.0V, Fv=60Hz,Is=55mA,Ta=25°

3. VDD=5.0V, Fv=60Hz,Is=55mA,Ta=25°C

Symbol	Description		Min.	Тур.	Max.	Unit	Remark
	William 1	(0.10	000		f . 1/ O	Note 1-1
Lw	White Luminance (Center of screen)		240	300		[cd/m2]	By SR-3
Luni	La color de la col		75	80		[0/]	Note 1-2
Lum	Luminance Uniformity	(9 points)	75	80		[%]	By SR-3
CR	Contrast Ratio (Center	of screen)	600-	1000	_	_	Note 1-3
	Contrast Natio (Center	or derecti,	000	1000			By SR-3
θR	Horizontal Viewing Angle	Right	75	89	-		
θL	(CR=10)	Left	75	89	-		
ФН	Vertical Viewing Angle	Up	75	89	-		
ΦL	(CR=10)	Down	75	89	-	[degree]	Note 1-4
θR	Horizontal Viewing Angle	Right	75	89	-	[uogioo]	By SR-3
θL	(CR=5)	Left	75	89			
ФН	Vertical Viewing Angle	Up	75	89	- \		
ΦL	(CR=5)	Down	75	89	O_{7J_J}		
Т _{стс}	Response Time Gray to Gray		-11	14 -	[msec]	Note 1-5	
I GIG	response rime	Gray to Gray	nāl			[mooo]	By TRD-100
Rx	ais Pl	Red x	0.617	0.647	0.677		
Ry	100	Red y	0.303	0.333	0.363		
Gx	AU DIS	Green x	0.278	0.308	0.338		
Gy	Color Coordinates	Green y	0.584	0.614	0.644	_	By SR-3
Bx	(CIE 1931)	Blue x	0.123	0.153	0.183	-	by SK-3
Ву		Blue y	0.016	0.046	0.076		
Wx	White x White y		0.283	0.313	0.343		
Wy			0.299	0.329	0.359		
	NTSC Area Ratio		0,	72	6	[%]	By SR-3
СТ	Crosstalk		2.1	73	1.5	[%]	Note 1-6
01	Ciossidik	al "ex	V. 9	1.5	1.5	[/0]	By SR-3
FdB	Flicker (Center of s	creen)	18:		-20	[dB]	Note 1-7
, ab	B Flicker (Center of screen)		•	20	[GD]	By SR-3	

Note 1-1: Equipment setup:

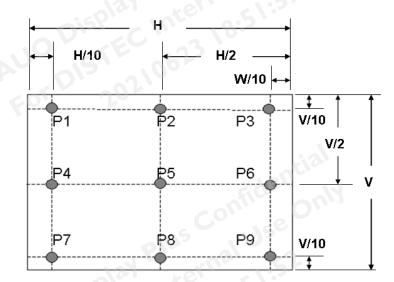


Note 1-2: Luminance Uniformity Measurement

Definition:

Luminance Uniformit
$$y = \frac{\text{Minimum Luminance of 9 Points (P1 } \sim \text{P9})}{\text{Maximum Luminance of 9 Points (P1 } \sim \text{P9})}$$

a. Test pattern: White Pattern





Note 1-3: Contrast Ratio Measurement

Definition:

Contrast Ratio = $\frac{\text{Luminance of White pattern}}{\text{Luminance of Black pattern}}$

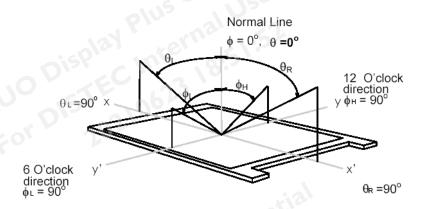
a. Measured position: Center of screen (P5) & perpendicular to the screen (θ = Φ =0°)

Note 1-4: Viewing angle measurement

Definition: The angle at which the contrast ratio is greater than 10 & 5.

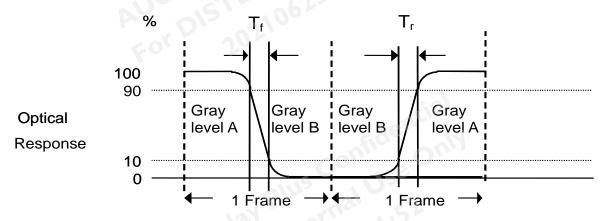
a. Horizontal view angle: Divide to left & right (θL & θR)

Vertical view angle: Divide to up & down (ΦH &ΦL)



Note 1-5: Response time measurement

The output signals of photo detector are measured when the input signals are changed from "Gray level A" to "Gray level B" (falling time, T_F), and from "Gray level B" to "Gray level A" (rising time, T_R), respectively. The response time is interval between the 10% and 90% of optical



response.



The gray to gray response time is defined as the following table.

Croy Loyal to Croy Loyal		Target gray level						
Gray Level to G	Gray Level to Gray Level		L63	L127	L191	L255		
	L0	500	re, o.e.					
	L63	LEC ,	03					
Start gray level	L127	5 10) P-					
	L191	50,7						
	L255							

■ T_{GTG_typ} is the total average time at rising time and falling time of gray to gray.

Note 1-6: Crosstalk measurement

Definition:

CT = Max. (CTH,CTV);

Where

a. Maximum Horizontal Crosstalk:

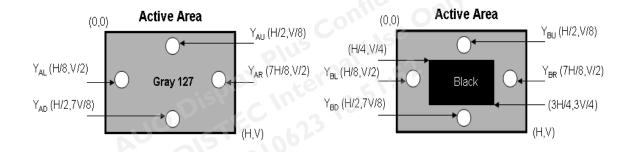
 $CTH = Max. (| YBL - YAL | / YAL \times 100 \%, | YBR - YAR | / YAR \times 100 \%);$

Maximum Vertical Crosstalk:

 $CTV = Max. (| YBU - YAU | / YAU \times 100 \%, | YBD - YAD | / YAD \times 100 \%);$

b. YAU, YAD, YAL, YAR = Luminance of measured location without Black pattern

YBU, YBD, YBL, YBR = Luminance of measured location with Black pattern

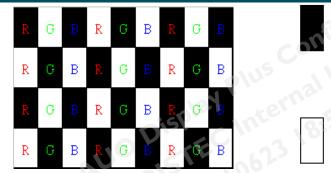


Note 1-7: Flicker measurement

a. Test pattern: It is listed as following.

Gray level = L0







b. Measured position: Center of screen (P5) & perpendicular to the screen ($\theta=\Phi=0^{\circ}$)



1.3. Mechanical Characteristics

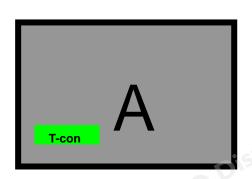
The contents provide general mechanical characteristics for the model P238HAN01.0 In addition the figures in the next page are detailed mechanical drawing of the LCD.

Item		Dimension	Unit	Note
	Horizontal	543.0	mm	
Outline Dimension	Vertical	317.4	mm	
	Depth (typ)	11.2	mm	
Weight	2280-	-/-80	nti ²¹ G	

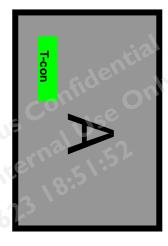
1.3.1. Placement Suggestions

- 1. Landscape Mode: The default placement is T-Con Side on the lower side and the image is shown upright via viewing from the front.
- Portrait Mode: The default placement is that T-Con side has to be placed on the left side via viewing from the front.

Landscape (Front view)

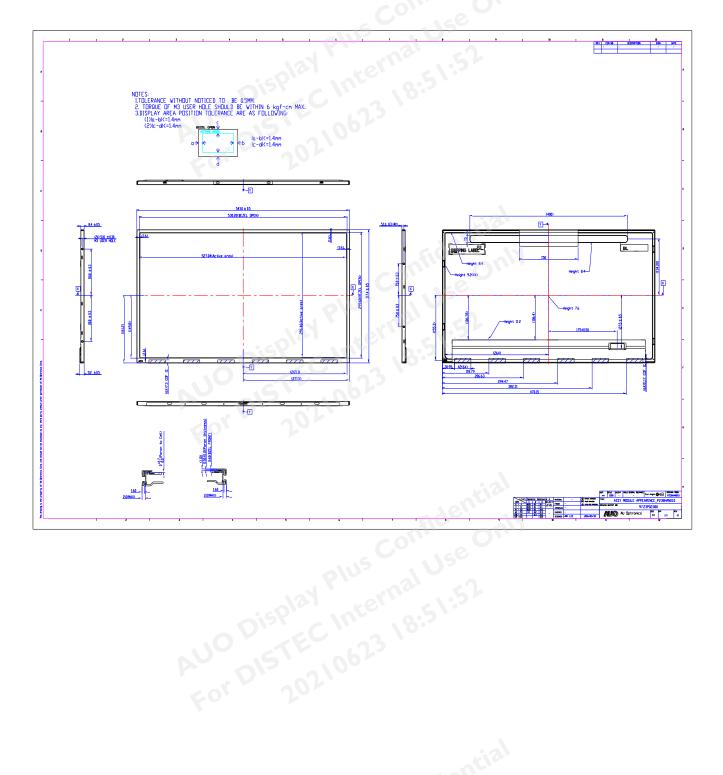


Portrait (Front view)





Mechanical Characteristics





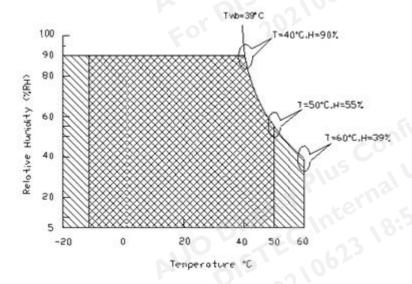
Absolute Maximum Ratings

The followings are maximum values which, if exceeded, may cause faulty operation or damage to the unit Permanent damage may occur if exceeding the following maximum rating.

Symbol	Description	Min.	Max.	Unit	Remark
ТОР	Operating Temperature	0	0 +50 [00		Note 2-1
TGS	Glass surface temperature (operation)	0 +65		[oC]	Note 2-1 Function judged only
НОР	Operation Humidity	5	90	[%RH]	Note 2-1
TST	TST Storage Temperature		+60	[oC]	
HST	Storage Humidity	5	90	[%RH]	

Note 2-1: Temperature and relative humidity range are shown as the below figure.

- 1. 90% RH Max ($Ta \le 39^{\circ}Q$
- 2. Max wet-bulb temperature at 39°Cor less. (Ta ≤ 39°C)
- 3. No condensation



Operating Range

Storage Range

+

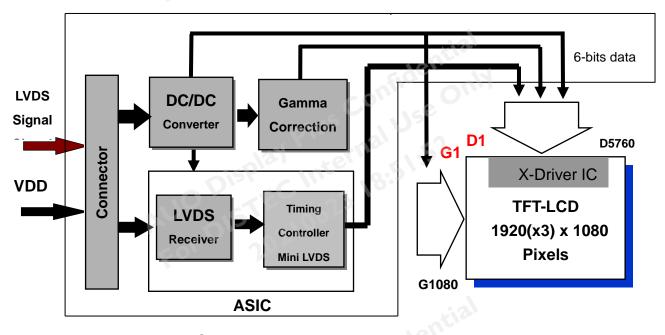


2. Electrical Specification

The P238HAN01.0 requires two power inputs. One is employed to power the LCD electronics and to drive the TFT array and liquid crystal. The other is to power Back Light Unit.

2.1. Block Diagram

The following shows the block diagram of the 23.8 inch Color TFT-LCD Module.





2.2. Interface Connection

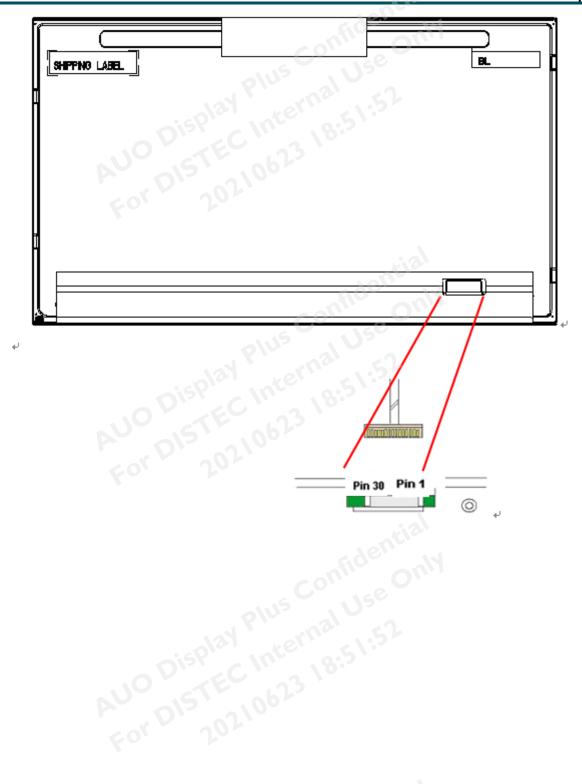
2.2.1. Connector Type

TFT-LCD	Manufacturer	P-TWO	STM	
Connector	Part Number	187034-3009	MSCKT2407P30HB	
Mating Connector	Manufacturer	JAE or Equivalent		
Mating Connector	Part Number	FI-X30HL (Locked Type)		

2.2.2. Connector Pin Assignment

PIN#	Symbol	Description	Remark			
1	RxO0-	Negative LVDS differential data input (Odd data)				
2	RxO0+	Positive LVDS differential data input (Odd data)				
3	RxO1-	legative LVDS differential data input (Odd data)				
4	RxO1+	Positive LVDS differential data input (Odd data)				
5	RxO2-	Negative LVDS differential data input (Odd data)				
6	RxO2+	Positive LVDS differential data input (Odd data)				
7	GND	Ground				
8	RxOCLK-	Negative LVDS differential clock input (Odd clock)				
9	RxOCLK+	Positive LVDS differential clock input (Odd clock)				
10	RxO3-	Negative LVDS differential data input (Odd data)				
11	RxO3+	Positive LVDS differential data input (Odd data)				
12	RxE0-	Negative LVDS differential data input (Even data)				
13	RxE0+	Positive LVDS differential data input (Even data)				
14	GND	Ground				
15	RxE1-	Negative LVDS differential data input (Even data)				
16	RxE1+	Positive LVDS differential data input (Even data)				
17	GND	Ground				
18	RxE2-	Negative LVDS differential data input (Even data)				
19	RxE2+	Positive LVDS differential data input (Even data)				
20	RxECLK-	Negative LVDS differential clock input (Even clock)				
21	RxECLK+	Positive LVDS differential clock input (Even clock)				
22	RxE3-	Negative LVDS differential data input (Even data)				
23	RxE3+	Positive LVDS differential data input (Even data)				
24	GND	Must Connect to GND				
25	NC	No connection (for AUO test only. Do not connect)				
26	NC	No connection (for AUO test only. Do not connect)				
27	NC	No connection (for AUO test only. Do not connect)				
28	VDD	Power Supply Input Voltage				
29	VDD	Power Supply Input Voltage				
30	VDD	Power Supply Input Voltage				







2.3. Electrical Characteristics

2.3.1. Absolute Maximum Rating

Permanent damage may occur if exceeding the following maximum rating.

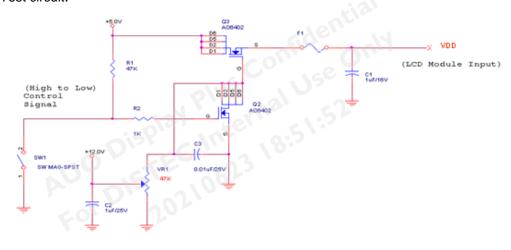
Symbol	Description	Min	Max	Unit	Remark
VDD	Power Supply Input Voltage	GND-0.3	6.0	[Volt]	Ta=25°C

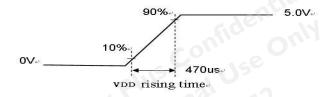
2.3.2. Recommended Operating Condition

Symbol	Description	Min	Тур	Max	Unit	Remark
VDD	Power supply Input voltage	4.5	5.0	5.5	[Volt]	atial
IDD	Power supply	i	0.6	0.72	[A]	VDD= 5.0V, All white Pattern, Fv=60Hz
טטו	Input Current (RMS)		0.7	0.84	[A]	VDD= 5.0V, All white Pattern, Fv=75Hz
DDD	VDD PowerVDD		3.0	3.6	[Watt]	VDD= 5.0V, All white Pattern, Fv=60Hz
PDD	Power Consumption	-	3.5	4.2	[Watt]	VDD= 5.0V, All white Pattern, Fv=75Hz
IRush	Inrush Current	Disp	EC 1	3.0	[A]	Note 3-1
VDDrp	Allowable VDD Ripple Voltage	O'S'	07.15	500	[mV]	VDD= 5.0V, All white Pattern, Fv=75Hz

Note 3-1: Inrush Current measurement:

Test circuit:





The duration of VDD rising time: 470us.

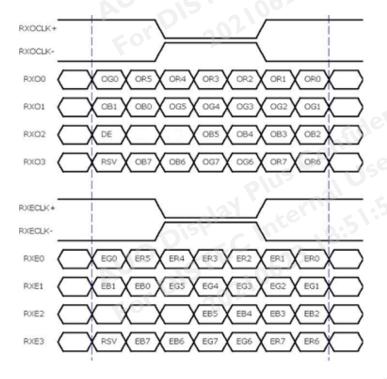


2.4. Signal Characteristics

2.4.1. LCD Pixel Format

naracteristic cel Format	<u>s</u>							o'	nfider	Oul	1					
		1			2		olus C				19	91	9	19	920)
1st Line	R	G	В	R	G	В	Interi	70	.51.5	L	R	G	В	R	G	В
AUG							10623		· -			-				
FO	C								· ·			-			-	
		:			:							:			:	
		:			:							:				
		:			•				fider		7	•			•	
1080 Line	R	G	В	R	G	В	plus C	0	ne ₆	0	R	G	В	R	G	В
			46	9												
ata Format)															
, AU																

2.4.2. LVDS Data Format



211 211	8 Bit Color Bit Order										
MSB	R7	G7	B7								
	R6	G6	B6								
	R5	G5	B5								
	R4	G4	B4								
	R3	G3	B3								
	R2	G2	B2								
	R1	G1	B1								
LSB	R0	G0	В0								

Note 3-2:

a. O = "Odd Pixel Data" E = "Even Pixel Data"

b. Refer to 3.4.1 LCD pixel format, the 1st data is 1 (Odd Pixel Data), the 2nd data is 2 (Even Pixel Data) and the last data is 1920 (Even Pixel Data).



2.4.3. Color versus Input Data

The following table is for color versus input data (8bit). The higher the gray level, the brighter the color.

							•. 6	-0			~*	Col	or Ing	out D	ata	5	•									
Color	Gray Level					data LSE		-	60					N da LSE		ı						E data)		Remark
		R7	R6	R5	R4	R3	R2	R1	R0	G7	G6	G5	G4	G3	G2	G1	G0	В7	B6	B5	B4	ВЗ	B2	B1	BO	
Black	-	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	
White	-	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	
Gray 127	-	0	1	1	1	1	1	1	1	0	1	1	1	1	1	1	1	0	1	1	1	1	1	1	1	
	9	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	Black
Red						• • •	• • •	**		:	:		0			:(Di.		:	:	:	:	:	:	:	
	L255	1	1	1	1	1	1	1	1	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	
	ம	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	Black
Green	:	:	:	:	:	:	Di V			: \	(;	:	1:8		:	:	:	:	:	:	:	:	:	:	:	
	L255	0	0	0	0	0	0	0	0	1	1	1	1	1	1	1	1	0	0	0	0	0	0	0	0	
	ம	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	Black
Blue	:	:	:	:	-0	:				:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	
	L255	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	1	1	1	1	1	1	1	1	

2.4.4. LVDS Specification

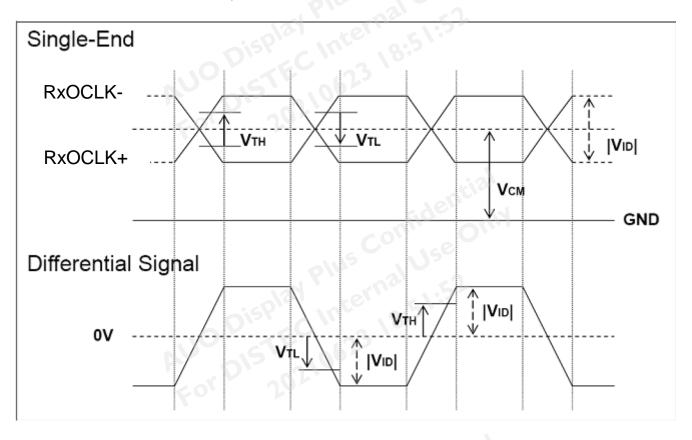
a. DC Characteristics:

Symbol	Description	Mi	n	Тур	Max	Units	Condition	
VTH	LVDS Differential Inp	out _		123	+100	[mV]	VCM = 1.2V	
VTL	LVDS Differential Inp	out -10	0	-	-	[mV]	VCM = 1.2V	
VID	LVDS Differential Inp	out 10	0	-	600	[mV]		
VCM	LVDS Common Mod Voltage	de +1.	0	+1.2	+1.5	[V]	VTH-VTL = 200mV	



LVDS Signal Waveform:

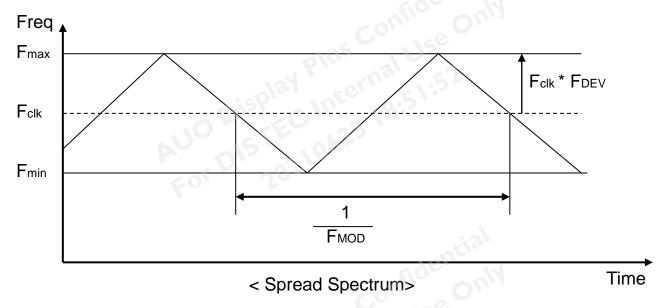
Use RxOCLK- & RxOCLK+ as example.



b. AC Characteristics:

Symbol	Description	Min	Max	Unit	Remark
FDEV	Maximum deviation of input clock frequency during Spread Spectrum	2623 I	± 3	%	
FMOD	Maximum modulation		000		
FMOD	frequency of input clock during Spread Spectrum	-	200	KHz	





Fclk: LVDS Clock Frequency



2.4.5. Input Timing Specification

It only support DE mode, and the input timing are shown as the following table.

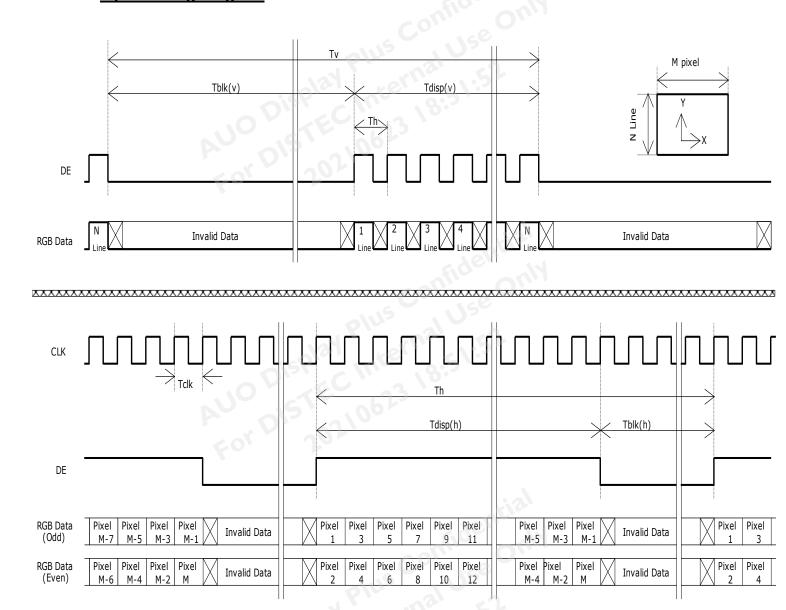
Symbol	Descript	tion Jus	Min.	Тур.	Max.	Unit	Remark
Tv	isf	Period	1094	1130	1836	Th	
Tdisp (v)	Vertical Section	Active	1080	1080	1080	Th	
Tblk (v)	vertical Section	Blanking	14	50	756	Th	
Fv	Y •	Frequency	49	60	76	Hz	
Th		Period	1000	1050	1678	Tclk	
Tdisp (h)	Horizontal	Active	960	960	960	Tclk	
Tblk (h)	Section	Blanking	40	90	718	Tclk	
Fh		Frequency	53.7	67.8	90.0	KHz	Note 3-3
Tclk	LVDS Clock	Period	11.2	14.0	18.6	ns	1/Fclk
Fclk	LVD3 Glock	Frequency	53.7	71.2	90.0	MHz	Note 3-4

Note 3-3: The equation is listed as following. Please don't exceed the above recommended value.

Note 3-4: The equation is listed as following. Please don't exceed the above recommended value.



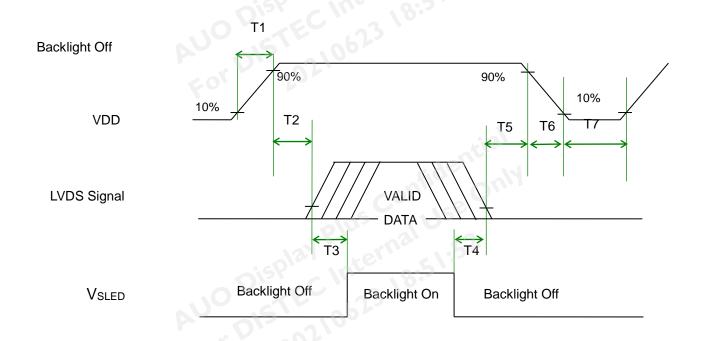
2.4.6. Input Timing Diagram





2.5. Power ON/OFF Sequence

VDD power,LVDS signal and backlight on/off sequence are as following. LVDS signals from any system shall be Hi-Z state when VDD is off.



Power Sequence Timing

Comple of		Value) III	Remark
Symbol	Min.	Тур.	Max.	Unit	
T1	0.5	-71-	10	[ms]	
T2	0	Pla - Int	50	[ms]	
Т3	500	160.	3	[ms]	
T4	100	100	-	[ms]	
T5	0	201	50	[ms]	Note 3-5 Note 3-6
Т6	0	-	200	[ms]	Note 3-6 Note 3-7
T7	1000	-	Gide	[ms]	

Note 3-5: Recommend setting T5 = 0ms to avoid electronic noise when VDD is off.

Note 3-6: During T5 and T6 period, please keep the level of input LVDS signals with Hi-Z state.

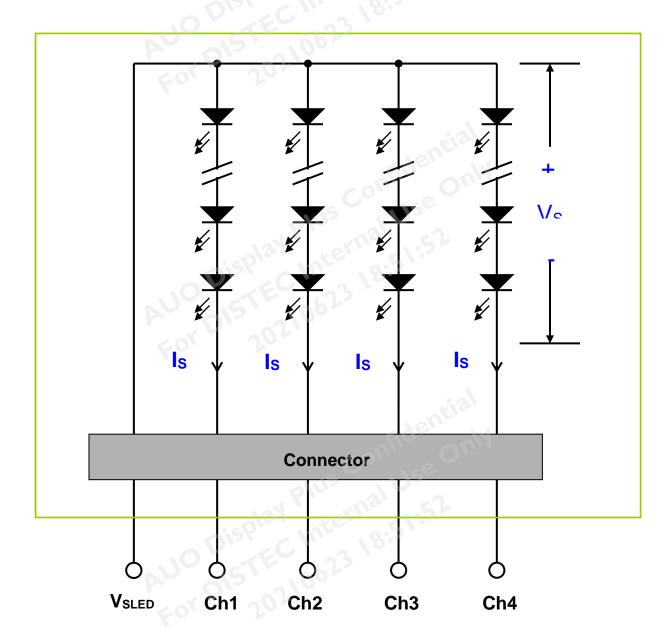
Note 3-7: Voltage of VDD must decay smoothly after power-off. (customer system decide this value)



3. Backlight Unit

3.1. Block Diagram

The following shows the block diagram of the 23.8 inch Backlight Unit. And it includes 68 pcs LED in the LED light bar. (4 strings and 17 pcs LED of one string).





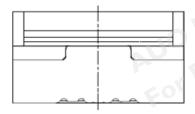
3.2. Interface Connection

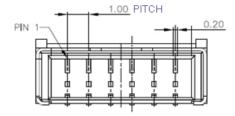
3.2.1. Connector Type

			R
.2. <u>Interface Connection</u> 3.2.1. <u>Connector</u>		s Confidence Only	
	Manufacturer	ENTERY	
Backlight Connector	Part Number	3707K-S06N-21R (BLACK) (Locking Type, Wire Harness)	
FO'	Manufacturer	ENTERY or Equivalent	
Mating Connector	Part Number	H112K-P06N-00B (Non-Locking type) H112K-P06N-03B (Locking type)	

Backlight Connector dimension:

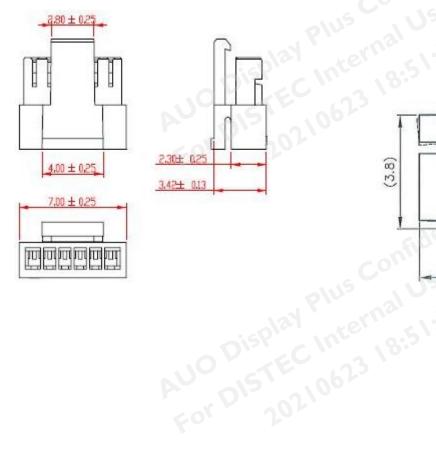
HxVxD=7.9x3.05x4.25, Pitch=1.0(unit=mm)

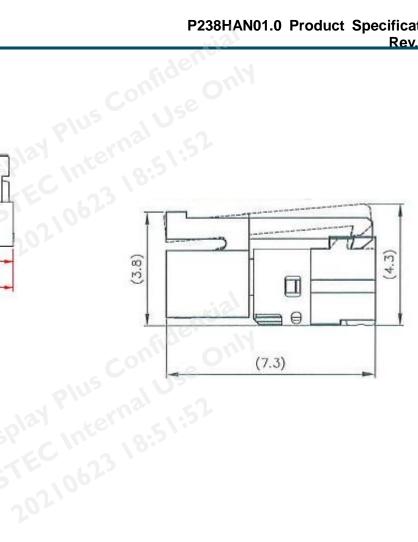






Mating Connector dimension:

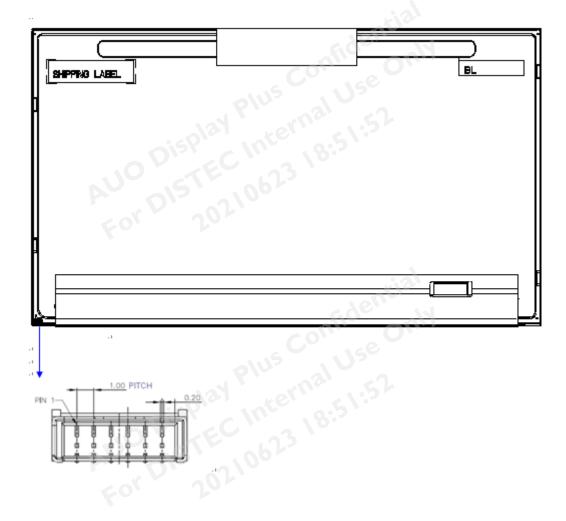






3.2.2. **Connector Pin Assignment**

3.2.2.	<u>Conne</u>	ctor Pin Assignment								
Pin#	Symbol	Description	Remark							
1	Ch1	LED Current Feedback Terminal (Channel 1)								
2	Ch2	LED Current Feedback Terminal (Channel 2)								
3	Vsled	LED Power Supply Voltage Input Terminal								
4	Vsled	LED Power Supply Voltage Input Terminal								
5	Ch3	LED Current Feedback Terminal (Channel 3)								
6	Ch4	LED Current Feedback Terminal (Channel 4)								





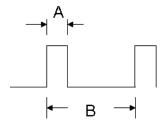
3.3. Electrical Characteristics

3.3.1. **Absolute Maximum Rating**

Permanent damage may occur if exceeding the following maximum rating.

(Ta=25°C)

Symbol	Description	Min	Max	Unit	Remark
	ODISTE	90 [mA] 100		100% duty ratio	
Is	LED String Current	0	150	[m A]	Duty ratio≦ 10%
	201 207		150	[mA]	Pulse time=10 ms

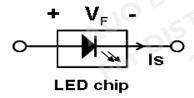


Duty ratio	D= (A / B) X 100%; (A: Pulse	time, B: Period)				
3.3.2.	<u>Recommended</u>	Operating C	onditioi	<u>1</u>		
						(Ta=25°C)
Symbol	Description	Min.	Тур.	Max.	Unit	Remark
ls	LED String Current	-	55	60	[mA]	100% duty ratio of LEC chip, <i>Note 4-6</i>
Vs	LED String Voltage	45.9	52.7	59.5	[Volt]	Is=55mA @ 100% duty ratio; Note 4-1, Note 4-5, Note 4-7
ΔVs	Maximum Vs Voltage Deviation of light bar	57EC 106	13.	3.4	[Volt]	Is=55mA @ 100% duty
P _{BLU}	LED Light Bar Power Consumption	79-	11.6	13.1	[Watt]	Note 4-3
LT _{LED}	LED Life Time	50,000	-	k	[Hour]	Note 4-4
OVP	Over Voltage Protection in system board	110% Vs (max)	Cox	fiden	[Volt]	Note 4-5
	NO DI	y Plu	ernal	Use .51.57	>	I



Note 4-1: Vs (Typ.) = V_F (Typ.) X LED No. (one string);

- a. V_F: LED chip forward voltage, V_F (Min.)= 2.7V, V_F(Typ.)=3.1V, V_F(Max.)=3.5V
- b. The same euqation to calculate Vs(Min.) & Vs (Max.) for respective V_F (Min.) & V_F(Max.);



- **Note 4-2:** ΔVs (Max.) = ΔV_F X LED No. (one string);
 - a. ΔV_F: LED chip forward voltage deviation; (0.2V, each Bin of LED V_F)
- Note 4-3: PBLU (Typ.) = Vs (Typ.) X Is (Typ.) X 4; (4 is total String No. of LED Light bar) P_{BLU} (Max.) = Vs (Max.) X Is (Typ.) X 4;
- Note 4-4: Definition of life time:
 - a. Brightness of LED becomes to 50% of its original value
 - b. Test condition: Is = 55mA and 25°C (Room Temperature)
- **Note 4-5:** Recommendation for LED driver power design:

Due to there are electrical property deviation in LED & monitor set system component after long time operation. AUO strongly recommend the design value of LED driver board OVP (over voltage protection) should be 10% higher than max. value of LED string voltage (Vs) at least.

- Note 4-6: AUO strongly recommend "Analog Dimming" method for backlight brightness control for Wavy Noise Free. Otherwise, recommend that Dimming Control Signal (PWM Signal) should be synchronized with Frame Frequency.
- Ensure that the LED light bar is not subjected either forward or reverse voltage while monitor set is on Note 4-7: standby mode or not in use.



Reliability Test Items		
AUO reliability test items are listed as fo	ollowing table. (Bare Panel only)	
Items	Condition	Remark
Temperature Humidity Bias (THB)	Ta= 50°C, 80%RH, 300hours	
High Temperature Operation (HTO)	Ta= 50°C, 50%RH, 300hours	
Low Temperature Operation (LTO)	Ta= 0°C, 300hours	
High Temperature Storage (HTS)	Ta= 60°C, 300hours	
Low Temperature Storage (LTS)	Ta= -20°C, 300hours	
Vibration Test	Acceleration: 1.5 Grms Wave: Random	
(Non-operation)	Frequency: 10 - 200 Hz	
(Non operation)	Sweep: 30 Minutes each Axis (X, Y, Z)	
PO . 01	Acceleration: 50 G	
Shock Test	Wave: Half-sine	
(Non-operation)	Active Time: 20 ms	
	Direction: ±X, ±Y, ±Z (one time for each Axis)	



4. Reliability Test Items

AUO reliability test items are listed as following table. (Bare Panel only)

Items	Condition	Remark
Temperature Humidity Bias (THB)	Ta= 50°С, 80%RH, 300hours	
High Temperature Operation (HTO)	Ta= 50°C, 50%RH, 300hours	
Low Temperature Operation (LTO)	Ta= 0°C, 300hours	
High Temperature Storage (HTS)	Та= 60°С, 300hours	
Low Temperature Storage (LTS)	Ta= -20°C, 300hours	
	Acceleration: 1.5 Grms	
Vibration Test	Wave: Random	
(Non-operation)	Frequency: 10 - 200 Hz	
NO -	Sweep: 30 Minutes each Axis (X, Y, Z)	
L'O'	Acceleration: 50 G	
Shock Test	Wave: Half-sine	
(Non-operation)	Active Time: 20 ms	
	Direction: ±X, ±Y, ±Z (one time for each Axis)	



5. International Standard

5.1. Safety

- Use Only (1) UL 60950-1; Standard for Safety of Information Technology Equipment Including electrical Business Equipment.
- (2) IEC 60950-1; Standard for Safety of International Electrotechnical Commission
- (3) EN 60950-1; European Committee for Electrotechnical Standardization (CENELEC), EUROPEAN STANDARD for Safety of Information Technology Equipment Including Electrical Business Equipment.

5.2. EMC

- (1) ANSI C63.4 "Methods of Measurement of Radio-Noise Emissions from Low-Voltage Electrical and Electrical Equipment in the Range of 9kHz to 40GHz. "American National standards Institute(ANSI), 1992
- (2) C.I.S.P.R "Limits and Methods of Measurement of Radio Interface Characteristics of Information Technology Equipment." International Special committee on Radio Interference.
- (3) EN 55022 "Limits and Methods of Measurement of Radio Interface Characteristics of Information Technology Equipment." European Committee for Electrotechnical Standardization. (CENELEC), 1998



6. Packing

Definition of Label

A. Panel Label:



Green mark description

- (1) For Pb Free Product, AUO will add
- (2) For RoHs compatible products, AUO will add RoHS for identification.

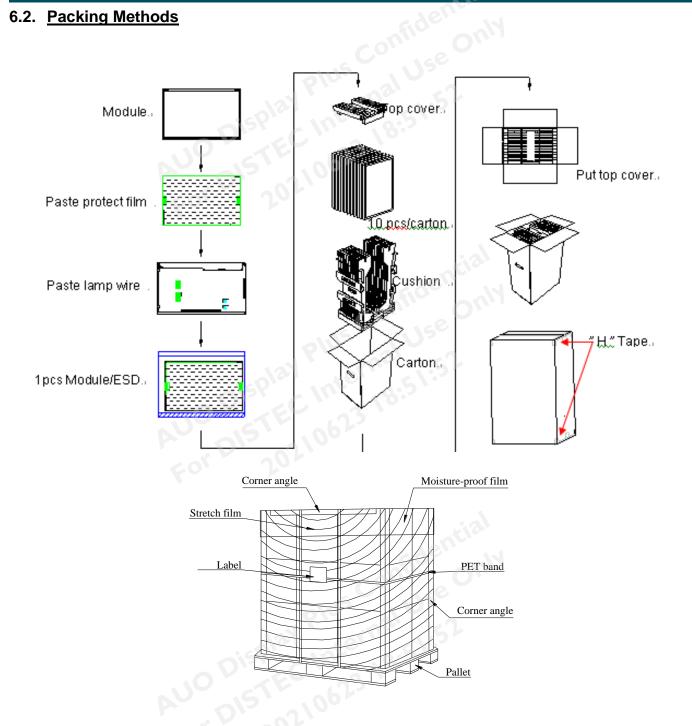
Note: The green Mark will be present only when the green documents have been ready by AUO internal green team. (definition of green design follows the AUO green design checklist.)

B. Carton Label:





6.2. Packing Methods





6.3. Pallet and Shipment Information

6.	6.3. Pallet and Shipment Information							
		Specification						
	Item	Q'ty	Dimension	Weight(kg)	Remark			
1	Panel	AU1	543.0(H) x 317.4(V) x 11.2(D) (Typ.)	2.280	Note 1			
2	Cushion	- 1	-201	1.7				
3	Вох	1	406(L)mm x 281(W)mm x 651(H)mm	1.2	without Panel & cushion Note 1			
4	Packing Box	10 pcs/Box	406(L)mm x 281(W)mm x 651(H)mm	25.7	with panel & cushion Note 1			
5	Pallet	0	1150(L)mm x 840(W)mm x 138(H)mm	12	Note 1			
6	Pallet after Packing	16 boxes/pallet	1150(L)mm x 840(W)mm x 1440(H)mm	423.2	Note 1			

adata. Note 1: Estimated value which is subject to change based on real measured data.



7. Precautions

Please pay attention to the followings when you use this TFT LCD module.

7.1. Mounting Precautions

- (1) You must mount a module using holes arranged in four corners or four sides.
- (2) You should consider the mounting structure so that uneven force (ex. twisted stress) is not applied to module. And the case on which a module is mounted should have sufficient strength so that external force is not transmitted directly to the module.
- (3) Please attach the surface transparent protective plate to the surface in order to protect the polarizer. Transparent protective plate should have sufficient strength in order to the resist external force.
- (4) You should adopt radiation structure to satisfy the temperature specification.
- (5) Acetic acid type and chlorine type materials for the cover case are not desirable because the former generates corrosive gas of attacking the polarizer at high temperature and the latter cause circuit broken by electro-chemical reaction.
- (6) Do not touch, push or rub the exposed polarizer with glass, tweezers or anything harder than HB pencil lead. And please do not rub with dust clothes with chemical treatment. Do not touch the surface of polarizer for bare hand or greasy cloth. (Some cosmetics are detrimental to the polarizer.)
- (7) When the surface becomes dusty, please wipe gently with absorbent cotton or other soft materials like chamois soaks with petroleum benzene. Normal-hexane is recommended for cleaning the adhesives used to attach front/ rear polarizer. Do not use acetone, toluene and alcohol because they cause chemical damage to the polarizer.
- (8) Wipe off saliva or water drops as soon as possible. Their long time contact with polarizer causes deformations and color fading.
- (9) Do not open the case because inside circuits do not have sufficient strength.

7.2. Operating Precautions

- (1) The spike noise causes the mis-operation of circuits. It should be lower than following voltage: V=±200mV(Over and under shoot voltage)
- (2) Response time depends on the temperature. (In lower temperature, it becomes longer..)
- (3) Brightness depends on the temperature. (In lower temperature, it may become lower.) And in lower temperature, response time (required time that brightness is stable after turned on) becomes longer.
- (4) Be careful for condensation at sudden temperature change. Condensation makes damage to polarizer or electrical contacted parts. And after fading condensation, smear or spot will occur.
- (5) When fixed patterns are displayed for a long time, remnant image is likely to occur.
- (6) Module has high frequency circuits. Sufficient suppression to the electromagnetic interference shall be done by system manufacturers. Grounding and shielding methods may be important to minimize the interface.

7.3. Operating Condition for Public Information Display



The device listed in the product specification is designed and manufactured for PID (Public Information Display) application. To optimize module's lifetime and function, below operating usages are required.

- (1) Normal operating condition
 - A. Operating temperature: -10~50°C
 - B. Operating humidity: 10~90%
 - C. Display pattern: dynamic pattern (Real display).Note) Long-term static display would cause image sticking.
- (2) Operation usage to protect against image sticking due to long-term static display.
 - A. Suitable operating time: 16 hours or less a day.
 - B. Liquid Crystal refresh time is required. Cycling display between 5 minutes' information (static) display and 10 seconds' moving image.
 - C. Periodically change background and character (image) color.
 - D. Avoid combination of background and character with large different luminance.
- (3) Periodically adopt one of the following actions after long time display.
 - A. Running the screen saver (motion picture or black pattern)
 - B. Power off the system for a while
- (4) LCD system is required to place in well-ventilated environment. Adapting active cooling system is highly recommended.
- (5) Product reliability and functions are only guaranteed when the product is used under right operation usages. If product will be used in extreme conditions, such as high temperature/ humidity, display stationary patterns, or long operation time etc..., it is strongly recommended to contact AUO for filed application engineering advice. Otherwise, its reliability and function may not be guaranteed. Extreme conditions are commonly found at airports, transit stations, banks, stock market and controlling systems.

7.4. Electrostatic Discharge Control

Since a module is composed of electronic circuits, it is not strong to electrostatic discharge. Make certain that treatment persons are connected to ground through wristband etc. And don't touch interface pin directly.

7.5. Precautions for Strong Light Exposure

Strong light exposure causes degradation of polarizer and color filter.

7.6. Storage

When storing modules as spares for a long time, the following precautions are necessary.

- (1) Store them in a dark place. Do not expose the module to sunlight or fluorescent light. Keep the temperature between 5°Cand 35°Cat normal humidity.
- (2) The polarizer surface should not come in contact with any other object. It is recommended that they



be stored in the container in which they were shipped.

- (3) Storage condition is guaranteed under packing conditions.
- (4) The phase transition of Liquid Crystal in the condition of the low or high storage temperature will be recovered when the LCD module returns to the normal condition.

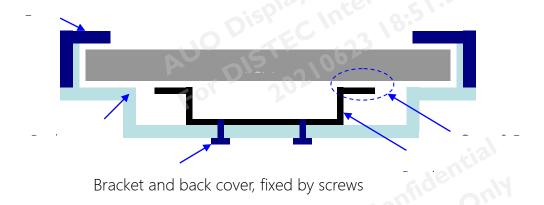
7.7. Handling Precautions for Protection Film

- (1) The protection film is attached to the bezel with a small masking tape. When the protection film is peeled off, static electricity is generated between the film and polarizer. This should be peeled off slowly and carefully by people who are electrically grounded and with well ion-blown equipment or in such a condition, etc.
- (2) When the module with protection film attached is stored for a long time, sometimes there remains a very small amount of glue still on the bezel after the protection film is peeled off.
- Lemains o (3) You can remove the glue easily. When the glue remains on the bezel or its vestige is recognized, please wipe them off with absorbent cotton waste or other soft material like chamois soaked with normal-hexane.

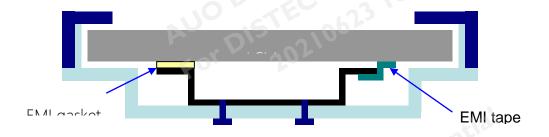


8. Design Guide for System

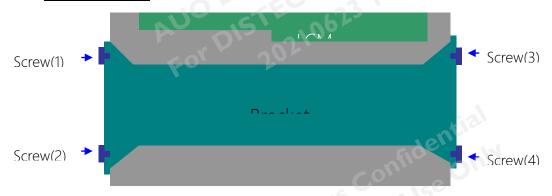
- 8.1. The gap between LCM and system rear bracket should be bigger than 0.5mm.
- 8.2. The system bracket should be fixed on back cover firmly.



8.3. The EMI gasket should be uniform and not push panel strongly.

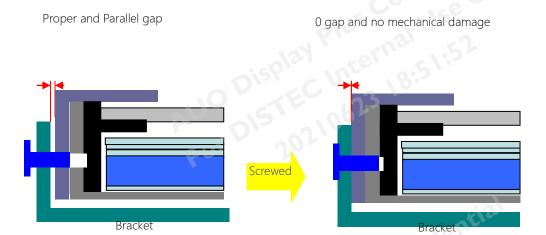


8.4. For stable assembly, the system bracket should use 4 screws to fix system and panel by dual sides.

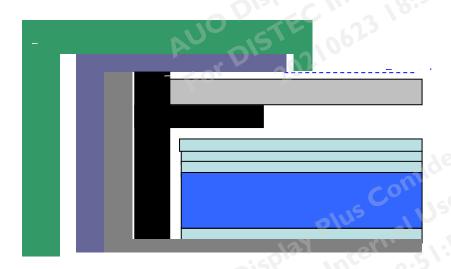




8.5. The system bracket and panel should be in parallel with having no gap after inserting screws.



8.6. Avoid scratching LCM, the rib on system front-cover should not exceed the bottom edge of LCM's front-bezel.







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